MOSFET – Power, Single, N-Channel, SO-8 FL 30 V, 48 A

Features

- Low R_{DS(on)} to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- Optimized Gate Charge to Minimize Switching Losses
- Optimized for 5 V, 12 V Gate Drives
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- CPU Power Delivery
- DC-DC Converters

MAXIMUM RATINGS (T_J = 25° C unless otherwise stated)

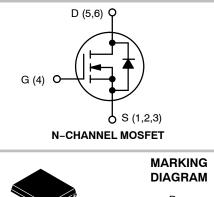
Para	meter		Symbol	Value	Unit
Drain-to-Source Volt	age		V _{DSS}	30	V
Gate-to-Source Volta	age		V _{GS}	±20	V
Continuous Drain Current R _{0JA}		T _A = 25°C	Ι _D	16.7	А
(Note 1)		$T_A = 100^{\circ}C$		10.5	
Power Dissipation $R_{\theta JA}$ (Note 1)		$T_A = 25^{\circ}C$	PD	2.70	W
Continuous Drain		T _A = 25°C	I _D	25.2	Α
Current $R_{\theta JA} \le 10 \text{ s}$ (Note 1)	Steady State	T _A = 100°C		15.9	
Power Dissipation $R_{\theta JA} \leq 10 \text{ s} \text{ (Note 1)}$		T _A = 25°C	PD	6.16	W
Continuous Drain		T _A = 25°C	Ι _D	9.7	Α
Current R _{0JA} (Note 2)		T _A = 100°C		6.2	
Power Dissipation $R_{\theta JA}$ (Note 2)		T _A = 25°C	P _D	0.92	W
Continuous Drain		$T_{C} = 25^{\circ}C$	Ι _D	48	Α
Current R _{θJC} (Note 1)		T _C =100°C		30	
Power Dissipation $R_{\theta JC}$ (Note 1)		T _C = 25°C	PD	23.2	W
Pulsed Drain Current	T _A = 25° V _G	C, t _p = 10 μs, _S = 10 V	I _{DM}	210	A
Current Limited by Pa	ickage	$T_A = 25^{\circ}C$	I _{Dmax}	100	А
Operating Junction ar Temperature	nd Storage		T _J , T _{STG}	–55 to +150	°C
Source Current (Body	v Diode)		۱ _S	21	Α
Drain to Source DV/D	Т		dV/d _t	6.0	V/ns

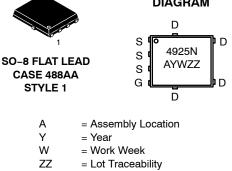


ON Semiconductor®

http://onsemi.com

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
30 V	5.6 m Ω @ 10 V	48 A
50 V	8.5 mΩ @ 4.5 V	40 A





ORDERING INFORMATION

Device	Package	Shipping [†]
NTMFS4925NT1G	SO-8 FL (Pb-Free)	1500 / Tape & Reel
NTMFS4925NT3G	SO-8 FL (Pb-Free)	5000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MAXIMUM RATINGS (T_J = 25°C unless otherwise stated)

Parameter	Symbol	Value	Unit
Single Pulse Drain-to-Source Avalanche Energy (T _J = 25°C, V _{DD} = 24 V, V _{GS} = 20 V, I _L = 26 A _{pk} , L = 0.1 mH, R _G = 25 Ω)	E _{AS}	34	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)	ΤL	260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Surface-mounted on FR4 board using 1 sq-in pad, 1 oz Cu.
Surface-mounted on FR4 board using the minimum recommended pad size.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case (Drain)	$R_{ heta JC}$	5.4	
Junction-to-Ambient - Steady State (Note 3)	R_{\thetaJA}	46.3	°C/W
Junction-to-Ambient - Steady State (Note 4)	R_{\thetaJA}	136.2	°C/W
Junction-to-Ambient – (t \leq 10 s) (Note 3)	R_{\thetaJA}	20.3	

Surface-mounted on FR4 board using 1 sq-in pad, 1 oz Cu.
Surface-mounted on FR4 board using the minimum recommended pad size.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = 250 μ A		30			V
Drain-to-Source Breakdown Voltage (transient)	V _{(BR)DSSt}	V_{GS} = 0 V, I _{D(aval)} = 11.0 A, T _{case} = 25°C, t _{transient} = 100 ns		34			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				21		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V,$	$T_J = 25^{\circ}C$			1.0	
		V _{DS} = 24 V	T _J = 125°C			10	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V_{DS} = 0 V, V_{GS}	= ±20 V			±100	nA

ON CHARACTERISTICS (Note 5)

Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$		1.32	1.7	2.2	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J	V_{GS} = 0 V, V_{DS} = 15 V			3.9		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	$V_{GS} = 10 \text{ V}$ $I_D = 30 \text{ A}$			4.5	5.6	
			I _D = 15 A		4.5		
		V _{GS} = 4.5 V	I _D = 30 A		6.8	8.5	mΩ
			I _D = 15 A		6.7		
Forward Transconductance	9 FS	V _{DS} = 1.5 V, I _D	= 15 A		52		S

CHARGES, CAPACITANCES & GATE RESISTANCE

Input Capacitance	C _{ISS}		1264		
Output Capacitance	C _{OSS}	V_{GS} = 0 V, f = 1 MHz, V_{DS} = 15 V	483		pF
Reverse Transfer Capacitance	C _{RSS}		143		
Capacitance Ratio	C _{RSS} / C _{ISS}	V_{GS} = 0 V, f = 1 MHz, V_{DS} = 15 V	0.113	0.226	

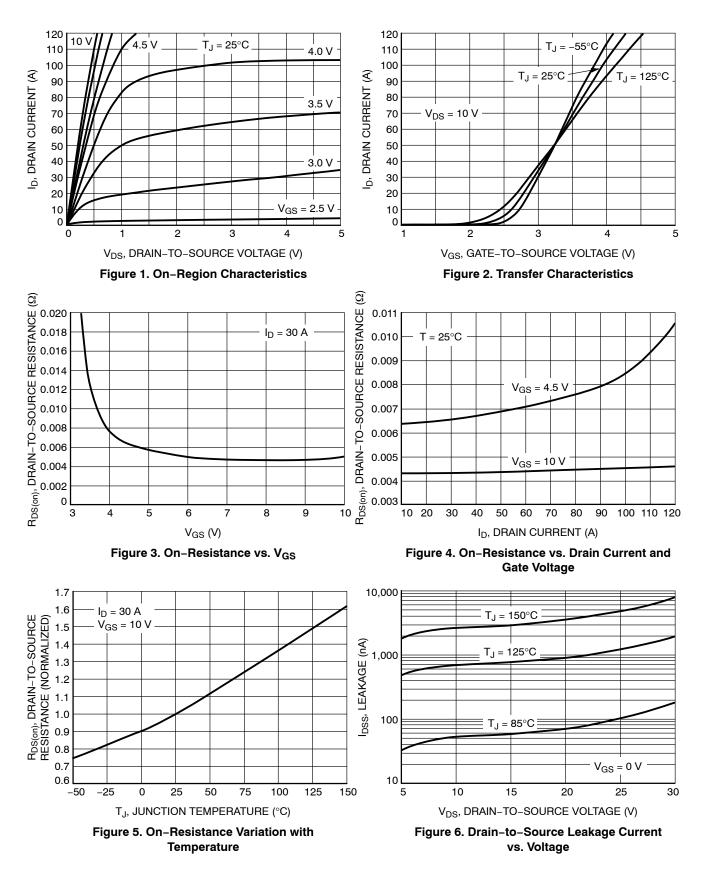
5. Pulse Test: pulse width \leq 300 µs, duty cycle \leq 2%. 6. Switching characteristics are independent of operating junction temperatures.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

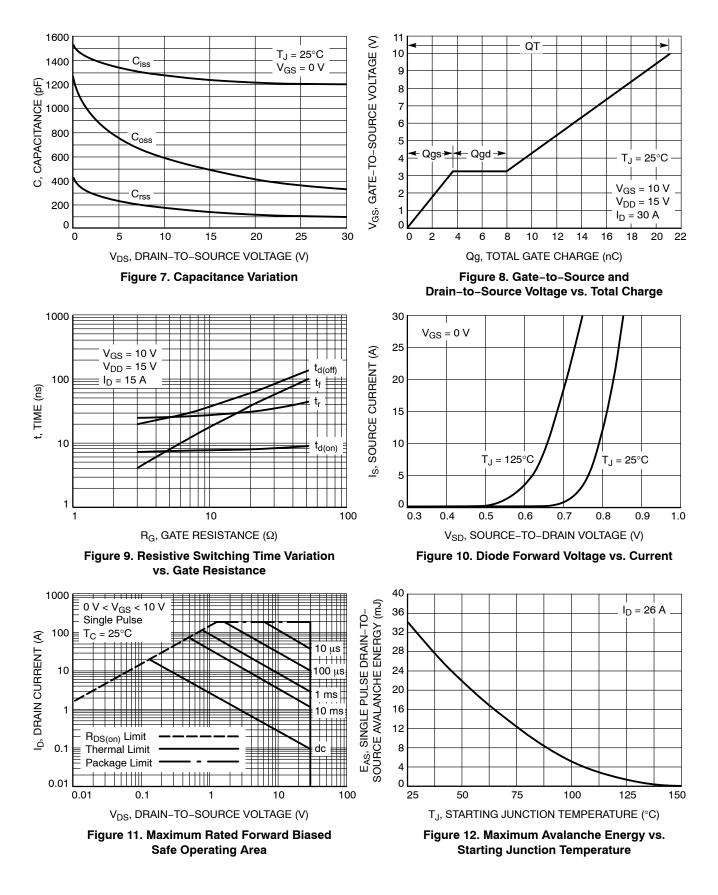
Parameter	Symbol	Test Conc	lition	Min	Тур	Max	Unit
CHARGES, CAPACITANCES & GATE	RESISTANCE						
Total Gate Charge	Q _{G(TOT)}			10.8			
Threshold Gate Charge	Q _{G(TH)}			2.0		nC	
Gate-to-Source Charge	Q _{GS}	V _{GS} = 4.5 V, V _{DS} =	V_{GS} = 4.5 V, V_{DS} = 15 V; I_{D} = 30 A		3.8		
Gate-to-Drain Charge	Q _{GD}				4.2		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} =	15 V; I _D = 30 A		21.5		nC
SWITCHING CHARACTERISTICS (N	ote 6)						
Turn-On Delay Time	t _{d(ON)}				9.5		
Rise Time	t _r	V_{GS} = 4.5 V, V_{DS} = 15 V, I _D = 15 A, R _G = 3.0 Ω			32.7		
Turn-Off Delay Time	t _{d(OFF)}				16.4		ns
Fall Time	t _f			6.2			
Turn-On Delay Time	t _{d(ON)}			7.4			
Rise Time	tr	V_{GS} = 10 V, V_{DS} = 15 V, I _D = 15 A, R _G = 3.0 Ω			27.5		1
Turn-Off Delay Time	t _{d(OFF)}				20.3		ns
Fall Time	t _f				4.1		1
DRAIN-SOURCE DIODE CHARACTE	RISTICS	-					-
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$		0.86	1.1	V
		V _{GS} = 0 V, I _S = 30 A	T _J = 125°C		0.75		v
Reverse Recovery Time	t _{RR}		•		25.8		
Charge Time	t _a	V _{GS} = 0 V, dIS/dt	= 100 A/μs,		12.4		ns
Discharge Time	t _b	I _S = 30	A		13.4		
Reverse Recovery Charge	Q _{RR}	1			13.6		nC
PACKAGE PARASITIC VALUES							
Source Inductance	L _S				1.00		nH
Drain Inductance	L _D		0		0.005		nH
Gate Inductance	L _G	T _A = 25	Ŭ		1.84		nH
Gate Resistance	R _G	1			0.8	2.2	Ω

Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

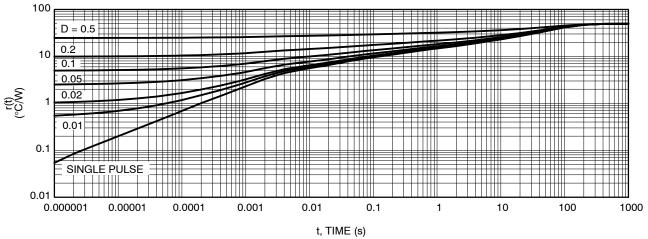


Figure 13. Thermal Response





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